

# SOT247-1

# plastic shrink dual in-line package; 52 leads (600 mil)

8 February 2016

**Package information** 

# 1. Package summary

Terminal position code D (double)

Package type descriptive code SDIP52

Package type industry code SDIP52

Package style descriptive code SDIP (shrink dual in-line package)

Package style suffix code NA (not applicable)

Package body material type P (plastic)

JEDEC package outline code MS-020

Mounting method type T (through-hole mount)

**Issue date** 13-2-2003

#### **Table 1. Package summary**

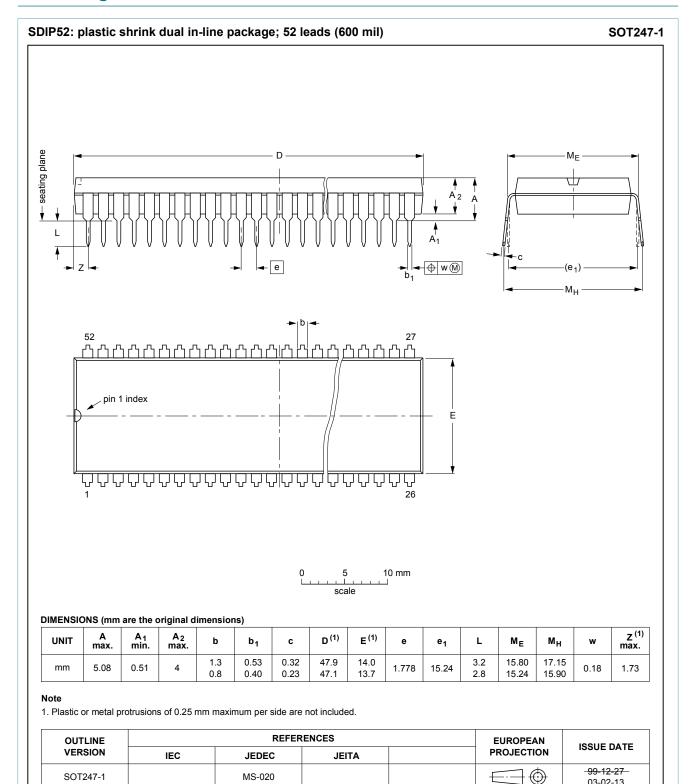
Symbol	Parameter	Min	Тур	Nom	Max	Unit
D	package length	47.1	-	47.5	47.9	mm
E	package width	13.7	-	13.85	14	mm
Α	seated height	[tbd]	-	5.08	5.08	mm
A <sub>2</sub>	package height	[tbd]	-	3.85	4	mm
n <sub>2</sub>	actual quantity of termination	-	-	52	-	



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### 2. Package outline



## Fig. 1. Package outline SDIP52 (SOT247-1)

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### 3. Legal information

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